## Designed as Surface-mounting Device

(SMD) Meeting High-density Mounting

## Requirements

- SMD Tactile Switch ideal for high-density mounting.
- Compact and more than 1 mm thinner than conventional tactile switches.
- Available with ground terminals for protection against static electricity.
■ Sealed construction conforming to IP64 (IEC-529) provides high reliability in dusty or humid environments.



## Ordering Information

## Model Number Legend:

B3SN-


1. Height

3: $\quad 3.1 \mathrm{~mm}$
2. Ground terminal

0 : Without ground terminal
1: With ground terminal
4. Operating force (OF)

2: $\quad 1.57 \mathrm{~N}\{160 \mathrm{gf}\}$
5. Shipment package

None: Bag
P: Embossed tape
3. Sealing

1: IP64 (IEC529)

- List of Models

| Type | Bags | Embossed tape (see note) |
| :--- | :--- | :--- |
| Without ground terminal | B3SN-3012 | B3SN-3012P |
| With ground terminal | B3SN-3112 | B3SN-3112P |

Note: Switches on embossed tape must be ordered in units of 3,000 pieces.
For details on packing, refer to Switch Pacing on pag 1 .

## Specifications

## ■ Ratings/Characteristics

| Switching capacity | 1 to $30 \mathrm{~mA}, 5$ to 24 VDC (resistive load) |
| :--- | :--- |
| Contact configuration | SPST-NO |
| Contact resistance | $100 \mathrm{~m} \Omega$ max. (initial value) (rated: $1 \mathrm{~mA}, 5 \mathrm{VDC}$ ) |
| Insulation resistance | $100 \mathrm{M} \Omega \mathrm{min}$. (at 250 VDC ) |
| Dielectric strength | $250 \mathrm{VAC}, 50 / 60 \mathrm{~Hz}$ for 1 min |
| Bounce time | 5 ms max. |
| Vibration resistance | Malfunction: 10 to $55 \mathrm{~Hz}, 1.5-\mathrm{mm}$ double amplitude |
| Shock resistance | Destruction: $1,000 \mathrm{~m} / \mathrm{s}^{2}$ \{approx. 100 G \} max. |
| Life expectancy | 100,000 operations min. |
| Ambient temperature | Operating: $-25^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ (with no icing) |
| Ambient humidity | Operating: $35 \%$ to $85 \%$ |
| Weight | Approx. 0.2 g |

## Engineering Data

Operating Force vs. Stroke (Typical)


Nomenclature


## Dimensions

Note: 1. All units are in millimeters unless otherwise indicated.
2. No terminal numbers are indicated on the Switches. The numbers used for terminals in the following graphics are indicated in the "Bottom View" diagram below. In this diagram, the Switch is rotated so that the terminals are on the right and left-hand sides, and the OMRON logo appears the right way up.

$$
\sqrt[3]{1}_{\sqrt[m m o m]{2}}^{4} \text { (Bottom View) }
$$

## Without Ground Terminal



## ■ Operating Characteristics

| Operating force (OF) | $1.57 \pm 0.49 \mathrm{~N}\{160 \pm 50 \mathrm{gf}\}$ max. |
| :--- | :--- |
| Releasing force (RF) | $0.29 \mathrm{~N}\{30 \mathrm{gf}\} \mathrm{min}$. |
| Pretravel (PT) | $0.25 \pm 0.15 \mathrm{~mm}$ |

## Precautions

## Soldering

Do not apply flow soldering, otherwise fragments of solder and flux may have a bad influence on the operation of the pushbutton.
Apply reflow soldering according to the optimum heating curve shown below. Reflow soldering equipment may have a high peak value. Be sure to conduct a test before use.
Soldering may be repeated only once at a minimum interval of five minutes if the Switch is not soldered properly.


Note: The above heating curve applies if the thickness of the circuit board is 1.6 mm .

Do not apply additional force to the plunger once it has stopped moving.
Do not repeatedly press the plunger off-center or from an acute angle.

## Cleaning

B3SN Switches are designed to allow submersed cleaning after soldering. When cleaning, follow the guidelines given as follows:

1. Clean with alcohol solvents. Do not use chlorine solvents or water.
2. When using ultrasonic cleaning in two- or three-tank systems, do not clean for more than one minute at a time or for more than three minutes total.
3. Do not apply external force to the Switch while cleaning.
4. Do not clean immediately after soldering. Allow components to stand for at least three minutes before cleaning if possible.
5. The Switch cannot be used where subject to direct contact with water.

## Switch Packing

Switches are packed on tape as shown below.


Tape drawing direction

| Package | 3,000 Switches |
| :--- | :--- |
| Heat resistance | $50^{\circ} \mathrm{C}$ for 24 hours (not to be deformed) |

Note: The ground terminals of the Switches are on the guide hole side of the package.

## ALL DIMENSIONS SHOWN ARE IN MILLIMETERS.

To convert millimeters into inches, multiply by 0.03937 . To convert grams into ounces, multiply by 0.03527 .

